# imall

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**New Product** 



Si4154DY Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

FREE

#### N-Channel 40-V (D-S) MOSFET

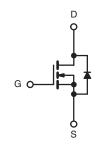
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
40	0.0033 at V <sub>GS</sub> = 10 V	36	32.5 nC		
	0.0039 at V <sub>GS</sub> = 4.5 V	33	32.5 110		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested ٠
- Compliant to RoHS Directive 2002/95/EC ٠

#### **APPLICATIONS**

- POL
- Synchronous Rectification



S D 8 1 D S 7 2 S D 6 3 D G 5 4 Top View

Ordering Information: SI4154DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		36		
Continuous Drain Current ( $T_{1} = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	1 [	26		
Continuous Drain Guirent (1) = 130 O)	T <sub>A</sub> = 25 °C	Ι <sub>D</sub>	24 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1 [	19 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	70	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1.	7.0		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	3.1 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	40		
Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	80	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		7.8		
	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5.0	w	
	T <sub>A</sub> = 25 °C	'D	3.5 <sup>b, c</sup>	V V	
	T <sub>A</sub> = 70 °C	1 1	2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Typical	Maximum
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16

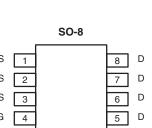
Notes:

a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.



Unit °C/W

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050		45		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	– Ι <sub>D</sub> = 250 μΑ		- 5.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.0		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0027	0.0033	<u> </u>	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.0032	0.0039	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		75		S	
Dynamic <sup>b</sup>	I						
Input Capacitance	C <sub>iss</sub>			4230			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		570		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			220			
Total Gate Charge		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		70	105	nC	
	Q <sub>g</sub>			32.5	49		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		9.7			
Gate-Drain Charge	Q <sub>gd</sub>	7		8.6			
Gate Resistance	Rg	f = 1 MHz	0.3	1.25	2.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			25	50	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		70	120		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 $\Omega$		51	90		
Fall Time	t <sub>f</sub>			35	60		
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 10 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		35	60		
Fall Time	t <sub>f</sub>	7		7	14		
Drain-Source Body Diode Characteristi	cs	·					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			7.0		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			1	70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.71	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			33	65	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			29	56	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		17		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1		16			

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

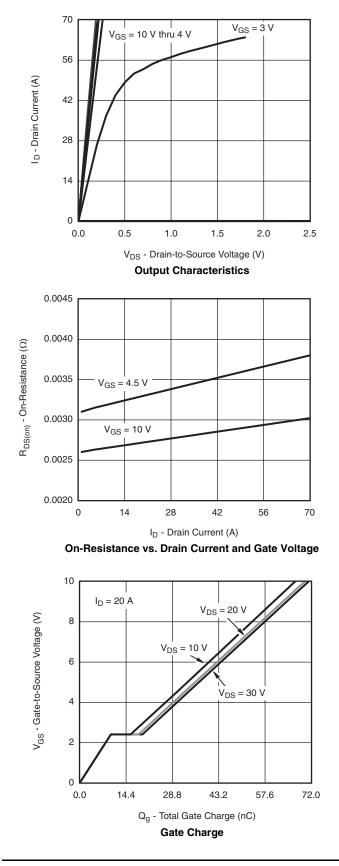
b. Guaranteed by design, not subject to production testing.

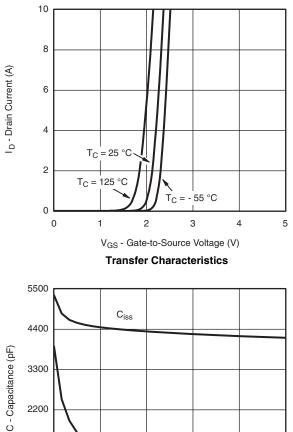
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

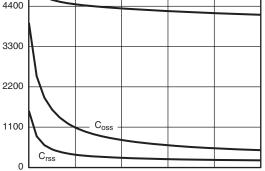


Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Capacitance

V<sub>DS</sub> - Drain-to-Source Voltage (V)

18

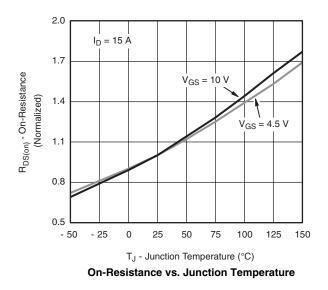
24

30

12

6

0



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 $I_D = 15 A$ 

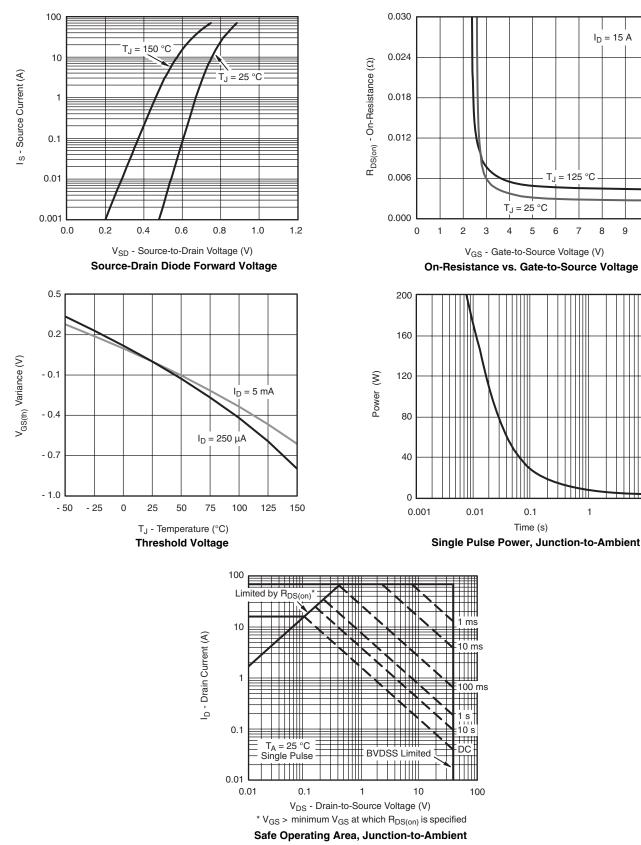
T<sub>J</sub> = 125 °C

1

10

6 7 8 9 10

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



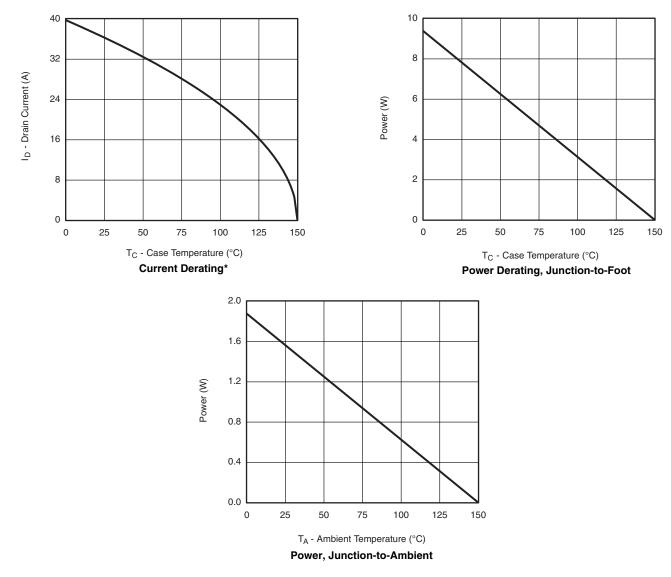
**New Product** 



### Si4154DY

Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

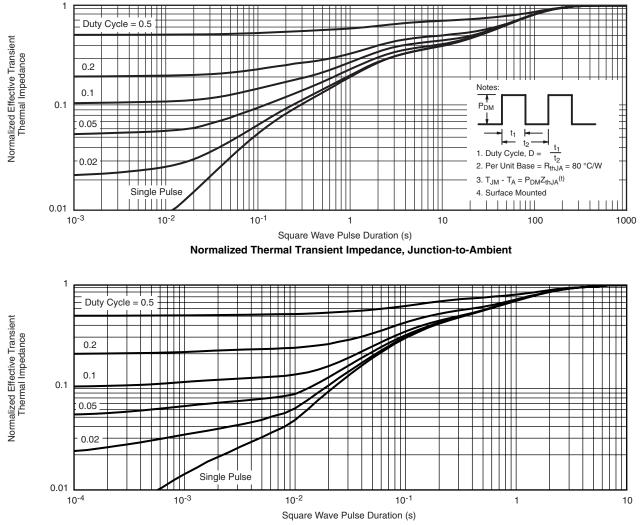


\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?65000">www.vishay.com/ppg?65000</a>.



Vishay

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